# DISPLAY Elektronik GmbH

# DATA SHEET

# LCD MODULE

# **DEM 20487 SYH-LY**

**Product Specification** 

**Version** : 3.1.1

# **GENERAL SPECIFICATION**

# MODULE NO.:

# **DEM 20487 SYH-LY**

VERSION NO.	CHANGE DESCRIPTION	DATE
0	ORIGINAL VERSION	12.02.2001
1	CHANGING EXTERNAL	21.02.2001
2	CHANGE BACKLIGHT CURRENT	30.03.2001
3	PCB CHANGED	12.10.2001
3.1.1	CHANGE IC	31.01.2008

PREPARED BY: OYQ DATE: 31.01.2008

APPROVED BY: MH DATE: 03.09.2008

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# 1. FUNCTIONS & FEATURES

MODULE	LCD TYPE
DEM 20487 SYH-LY	STN Yellow Green Transflective Positive Mode

• Viewing Direction : 6 O'clock

• Driving Scheme : 1/16 Duty Cycle, 1/5 Bias

Power Supply Voltage : 5.0V (typ.)
 Backlight Color : Yellow Green
 VLCD : 4.5V (typ.)

Display contents : 20 x 4 Characters
 Operating Temperature : -20°C to +70°C
 Storage Temperature : -30°C to +80°C

• Internal Memory : CGROM (10,080 bits )

: CGRAM (64 x 8 bits )

: DDRAM (80 x 8 bits for Digits)

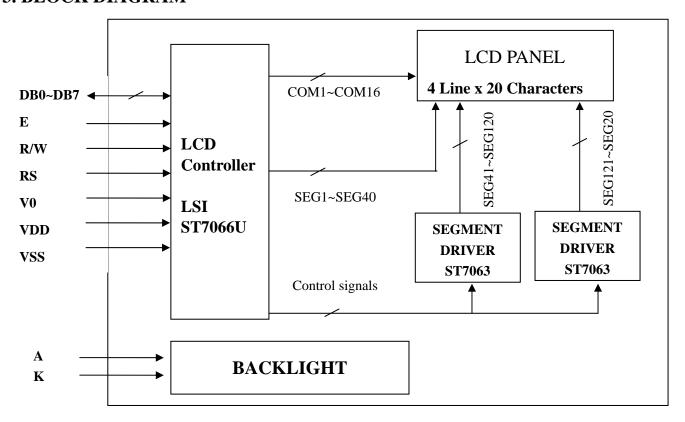
• Interface : Easy Interface with a 4-bit or 8-bit MPU

#### 2. MECHANICAL SPECIFICATIONS

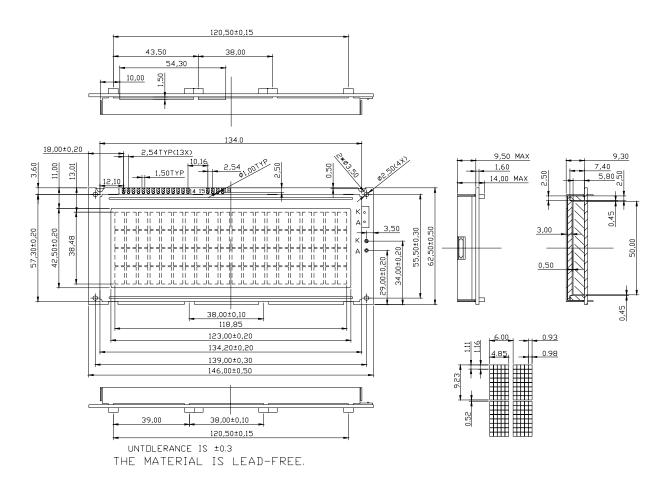
• Module Size : 146.00 x 62.50 x 14.00 mm

Character Pitch : 6.00 x 9.75 mm
 Character Size : 4.85 x 9.23 mm
 Character Font : 5 x 8 dots
 Dot Size : 0.93 x 1.11 mm
 Dot Pitch : 0.98 x 1.16 mm

### 3. BLOCK DIAGRAM



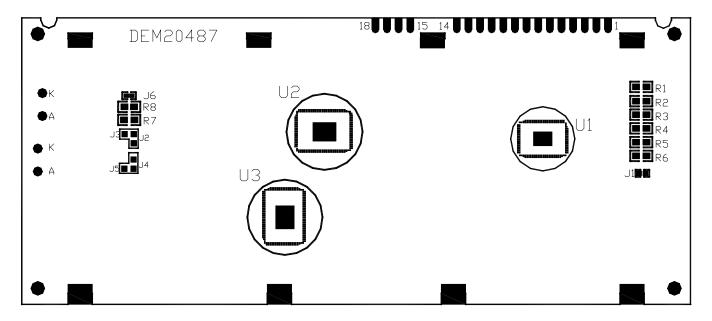
#### 4. EXTERNAL DIMENSIONS



## **5. PIN ASSIGNMENT**

Pin No.	Symbol	Function
1	Vss	Ground terminal of module
2	$V_{\mathrm{DD}}$	Power supply of module 5V
3	V <sub>0</sub>	Power Supply for LCD
4	RS	Register Select RS=0: Instruction Register; RS=1: Data Register
5	R/W	Read / Write R/W=0: Read; R/W=1: Write
6	Е	Enable
7	DB0	
8	DB1	
9	DB2	Bi-directional data bus, data transfer is performed once, thru DB0~DB7,
10	DB3	in the case of interface data. Length is 8-bit; and twice, thru DB4~DB7
11	DB4	in the case of interface data length is 4-bits.
12	DB5	Upper four bits first then lower four bits.
13	DB6	
14	DB7	
15	LED-(K)	Please also refer to 6.1 PCB drawing and description.
16	LED+(A)	Thease also refer to 0.1 1 CD drawing and description.

## 6. PCB DRAWING AND DESCRIPTION



Note: The part no. DEM 20487 is printed on the PCB.

#### **DESCRIPTION:**

#### 6-1-1. The polarity of the pin 15 and the pin 16

LED Polarity(1)								
15 Pin 16Pin								
Anode	Cathode							
J3=J5=open								
J2=J4=	closed							

LED Polarity(2)								
15 Pin	16 Pin							
Cathode	Anode							
J3=J5= closed								
J2=J4=	open							

Note: In application module, J2=J4= open and J3=J5=closed

#### 6-1-2. The metal-bezel should be on ground when the J1 is solder-Bridge.

Note: In application module, J1=closed

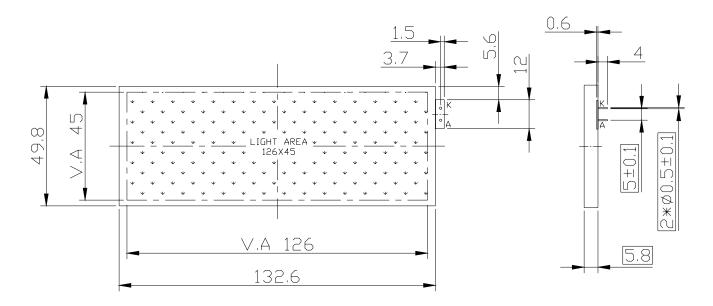
#### 6-1-3. The LED resistor should be bridged when the J6 is solder-Bridge.

Note: In application module, J6=open

#### 6-1-4. The R7 and the R8 are the LED resistor. R7=R8=10 Ohm

# 7. BACKLIGHT & SWITCH (Ta=-20~70°C)

	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS
Forward Voltage	V f		4.2	4.6	V	/ f =880mA
Forward Current	/ f		880	1760	mΑ	
Power Disdipation	Pd		3.7		W	/ <sub>f</sub> =880mA
Reverse Voltage	V R		10.0		V	
Reverse Current	/ R		0.20		mΑ	
Luminous Intensity	/ <sub>V</sub>	160	240		cd/m 2	/ <sub>f</sub> =880mA
Emission Wavelength	入 <i>P</i>		570		nm	l f =10 mA Ta=25°C
Luminous Uniformity		75			%	Each chip



REMARKS:

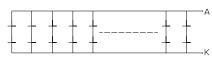
1,UNMARKED TOLERANCE IS ±0.3,

2,ALL MATERIAL COMPLY WITH ROHS,

3,COLOR: YELLOW-GREEN.

4.Electronics/Optical Specifications:

L MATERIAL COMPLY WITH ROHS, Electrical Circuit (88 x 2 = 176 pcs)



**IMPORTANT NOTE:** The LED-current of the module is limited to ~ 230mA due to the LED-resistors on board.

## 8. DISPLAY DATA RAM (DDRAM)

																D	ISPLA	AY PO	SITIE	]N –			$\neg$
	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	•		
FIRST LINE	00	01	02	03	04	05	06	07	08	09	OA	OB	ОС	0D	OE	OF	10	11	12	13	•	DDR ADI	RAM DRESS
SECOND LINE	40	41	42	43	44	45	46	47	48	49	4A	4B	4C	4D	4E	4F	50	51	52	53			
THIRDD	14	15	16	17	18	19	1A	1B	1C	1D	1E	1F	20	21	22	23	24	25	26	27			
FOURTH LINE	54	55	56	57	58	59	5A	5B	5C	5D	5E	5F	60	61	62	63	64	65	66	67			

# 9. MAXIMUM ABSOLUTE LIMIT (Ta=25°C)

Item	Symbol	Standard value	Unit
Power supply voltage (1)	$V_{\mathrm{DD}}$	-0.3~+7.0	V
Power supply voltage (2)	$V_0$	V <sub>DD</sub> -15.0~V <sub>DD</sub> +0.3	V
Input voltage	$V_{\mathrm{IN}}$	-0.3~V <sub>DD</sub> +0.3	V
Operating temperature	Topr	-20~+70	°C
Storage temperature	Tstg	-30~+80	°C

<sup>\*</sup>Voltage greater than above may damage to the Circuit.

VDD > V1 > V2 > V3 > V4 > V5

#### 10. ELECTRICAL CHARACTERISTICS

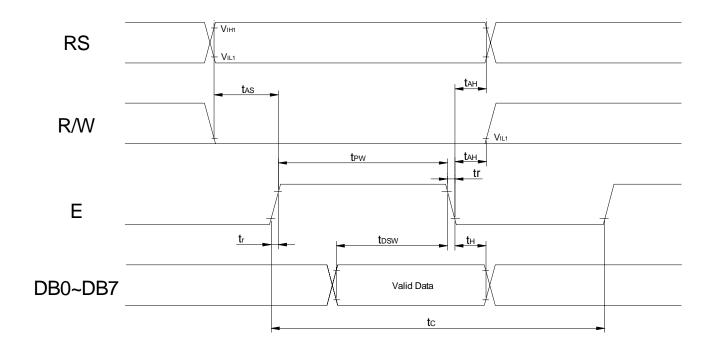
### 10-1 DC Characteristics(VDD=4.5V~5.5V,Ta=-20~+70°C)

Thomas	Cruss la ol		dard Va	lue	Test	T In:	
Item	Symbol	MIN	TYP	MAX	Condition	Unit	
Operating Voltage	$V_{\mathrm{DD}}$	4.5	5	5.5		V	
Supply Current	$I_{\mathrm{DD}}$		0.35	0.6	VDD=5V,fosc=270kHz	mA	
LCD Driving Voltage	VLCD	3.0	4.5	13.0	V <sub>DD</sub> -V <sub>5</sub> (1/5,1/4 Bias)	V	

## **10-2.** AC Characteristics (VDD=4.5V~5.5V , Ta=-20~+70°C)

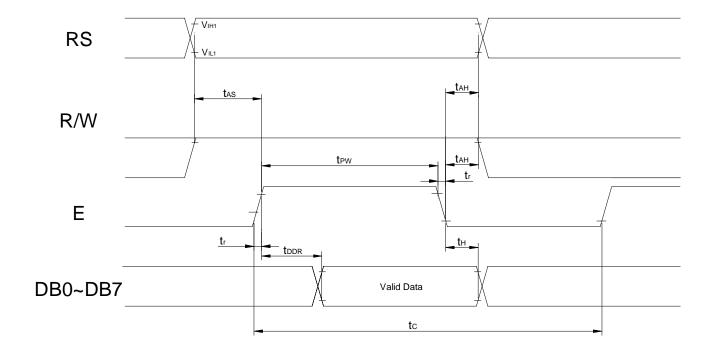
### 10-2-1 Write mode (writing data from MPU to module)

Characteristic	Symbol	Min	Type	Max	Unit	Test PIN
E Cycle Time	$t_{\rm C}$	1200			ns	Е
E Rise Time	$t_R$			25	ns	E
E Fall Time	$t_{\mathrm{F}}$			25	ns	E
E Pulse width (High,Low)	$t_{ m W}$	140			ns	E
R/W and RS Set-up Time	$t_{ m SU1}$	0			ns	R/W,RS
R/W and RS Hold Time	t <sub>H1</sub>	10			ns	R/W,RS
Data Set-up Time	$t_{ m SU2}$	40			ns	DB0~DB7
Data Hold Time	t <sub>H2</sub>	10			ns	DB0~DB7



10-2-2 Read mode (reading data from module to MPU)

Characteristic	Symbol	Min	Type	Max	Unit	Test PIN
E Cycle Time	$t_{\rm C}$	1200			ns	Е
E Rise Time	$t_{R}$			25	ns	Е
E Fall Time	$t_{\mathrm{F}}$			25	ns	Е
E Pulse width (High, Low)	$t_{ m W}$	140			ns	Е
R/W and RS Set-up Time	$t_{ m SU}$	0			ns	R/W,RS
R/W and RS Hold Time	$t_{H}$	10			ns	R/W,RS
Data Setup Time	$t_{\mathrm{D}}$			100	ns	DB0~DB7
Data Hold Time	t <sub>DH</sub>	10			ns	DB0~DB7



### 11. CONTROL AND DISPLAY COMMAND

Command	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Execution time (fosc=270KHz)	Remark			
Clear Display	0	0	0	0	0	0	0	0	0	1	1.52ms	Write"20H" to DDRAM. And set DDRAM address to "00H" from AC			
Return home	0	0	0	0	0	0	0	0	1	X	1.52ms	Set DDRAM address to "00H" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.			
Entry mode Set	0	0	0	0	0	0	0	1	I/D	S	37us	Sets cursor move direction and specifie display shift. These operations are performed during data write and read			
Display on/off control	0	0	0	0	0	0	1	D	С	В	37us	D=1: entire display on C=1: cursor on B=1: cursor position on			
Cursor or Display Shift	0	0	0	0	0	1	S/C	R/L	X	X	37us	Set cursor moving and display shift control bit, and the direction, without changing DDRAM data.			
function Set	0	0	0	0	1	DL	N	F	X	X	37us	DL: interface data is 8/4 bits N: number of line is 2/1 F: font size is 5x11/5x8			
Set CGRAM address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	37us	Set CGRAM address in address counter			
Set DDRAM address	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0	37us	Set DDRAM address in address counter			
Read busy flag& address	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Ous	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.			
Write data to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	37us	Write data into internal RAM (DDRAM/CGRAM)			
Read data from RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0	37us	Read data from internal RAM (DDRAM / CGRAM)			

#### Note:

Be sure the ST7066U is not in the busy state (BF=00 before sending an instruction from the MPU to the ST7066U. If an instruction is sent without checking the busy flag, the time between the first instruction and next instruction will take much longer than the instruction time itself. Refer to instruction table for the list of each instruction execution time.

# 12. STANDARD CHARACTER PATTERN (ST7066U-0A)

Upper(4 bit)	0000	0001	0010	0011	0100	0101	0110	0111	1000	1001	10010	1011	1100	1101	1110	1111
Lower(4bit) 0000	CGRAM (1)															
0001	(2)															
0010	(3)															
0011	(4)															
0100	(5)															
0101	(6)															
0110	(7)															
0111	(8)															
1000	(1)															
1001	(2)															
1010	(3)															
1011	(4)															
1100	(5)															
1101	(6)															
1110	(7)															
1111	(8)															

#### 13. LCD MODULES HANDLING PRECAUTIONS

- The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- If the display panel is damaged and the liquid crystal substance inside it leaks out, do not get any in your mouth. If the substance comes into contact with your skin or clothes promptly wash it off using soap and water.
- Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
  - -Be sure to ground the body when handling the LCD module.
  - -Tools required for assembly, such as soldering irons, must be properly grounded.
  - -To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
  - -The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.

#### Storage precautions

When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps. Keep the modules in bags designed to prevent static electricity charging under low temperature / normal humidity conditions (avoid high temperature / high humidity and low temperatures below 0°C). Whenever possible, the LCD modules should be stored in the same conditions in which they were shipped from our company.

#### 14. OTHERS

- Liquid crystals solidify at low temperature (below the storage temperature range) leading to defective orientation of liquid crystal or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subjected to a strong shock at a low temperature.
- If the LCD modules have been operating for a long time showing the same display, patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. Abnormal operating status can be resumed to be normal condition by suspending use for some time. It should be noted that this phenomena does not adversely affect performance reliability.
- To minimize the performance degradation of the LCD modules resulting from caused by static electricity, etc. exercise care to avoid holding the following sections when handling the modules:
  - Exposed area of the printed circuit board
  - Terminal electrode sections